

**Product Summary**

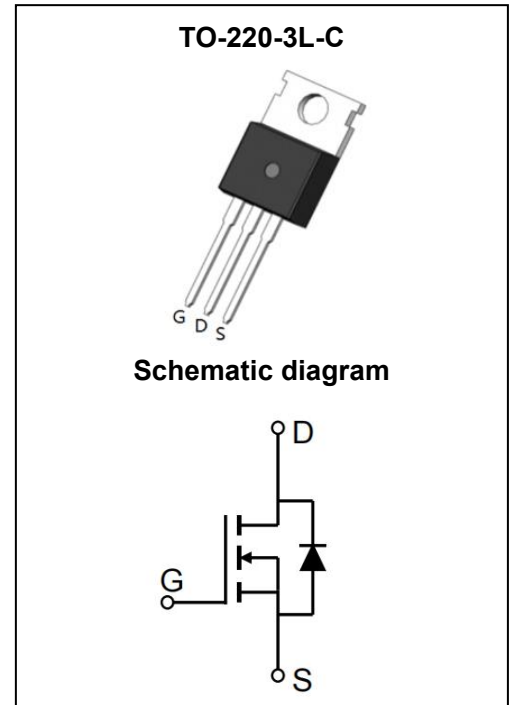
<b>V<sub>(BR)DSS</sub></b>	<b>R<sub>DS(on)TYP</sub></b>	<b>I<sub>D</sub></b>
150V	8.1mΩ@10V	84A

**Feature**

- Low R<sub>DS(ON)</sub>
- 100% EAS Guaranteed
- High Speed Power Switching

**Application**

- Load Switch
- PWM Application
- Power Management



**Package Marking and Ordering Information**

Part Number	Package	Marking	Packing	Reel Size	Qty
GPT081N15NTB	TO-220-3L-C	T081N15N	Tube	N/A	50pcs

**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain - source Voltage	V <sub>DS</sub>	150	V
Gate - source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub>	T <sub>C</sub> = 25°C	84
		T <sub>C</sub> = 100°C	59
Pulsed Drain Current <sup>1</sup>	I <sub>DM</sub>	336	A
Single Pulse Avalanche Energy <sup>2</sup>	E <sub>AS</sub>	536	mJ
Power Dissipation	P <sub>D</sub>	170	W
Thermal Resistance from Junction to Ambient <sup>3</sup>	R <sub>θJA</sub>	28	°C/W
Thermal Resistance from Junction to Case	R <sub>θJC</sub>	0.7	°C/W
Operating Junction And Storage Temperature	T <sub>J</sub> , T <sub>STG</sub>	-55~ +150	°C

**MOSFET ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C unless otherwise noted)**

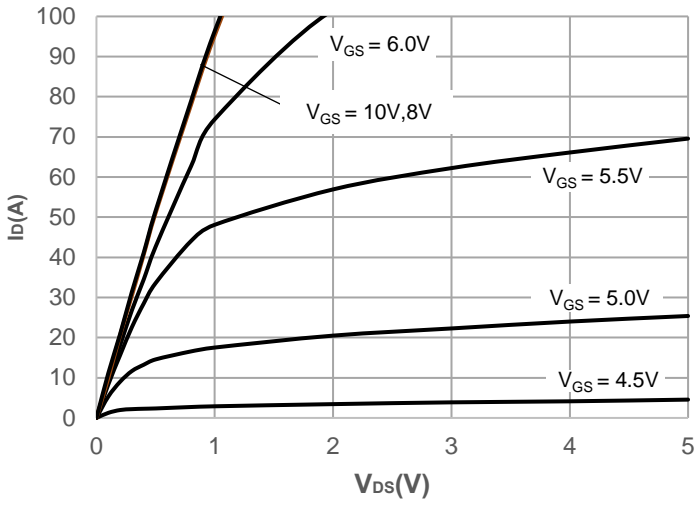
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Off Characteristics</b>						
Drain - source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	150			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 120V, V <sub>GS</sub> = 0V			1	μA
Gate - body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	nA
<b>On Characteristics</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2.2	3.2	4.1	V
Drain-source On-resistance <sup>4</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A		8.1	10.6	mΩ
<b>Dynamic Characteristics<sup>5</sup></b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 75V, V <sub>GS</sub> = 0V, f = 1MHz		3569		pF
Output Capacitance	C <sub>oss</sub>			323		
Reverse Transfer Capacitance	C <sub>rss</sub>			14		
Gate Resistance	R <sub>G</sub>	f=1MHz		3.7		Ω
<b>Switching Characteristics<sup>5</sup></b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 75V, I <sub>D</sub> = 20A V <sub>GS</sub> = 0 to 10V		53		nC
Gate-source Charge	Q <sub>gs</sub>			19		
Gate-drain Charge	Q <sub>gd</sub>			12		
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = 75V, V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A R <sub>G</sub> = 3Ω		16		ns
Turn-on Rise Time	t <sub>r</sub>			29		
Turn-off Delay Time	t <sub>d(off)</sub>			39		
Turn-off Fall Time	t <sub>f</sub>			16		
<b>Source - Drain Diode Characteristics</b>						
Diode Continuous current	I <sub>S</sub>				84	A
Diode Forward Voltage <sup>4</sup>	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A			1.2	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 15A, dI/dt = 100A/μs		85		ns
Reverse Recovery Charge	Q <sub>rr</sub>				253	

**Notes:**

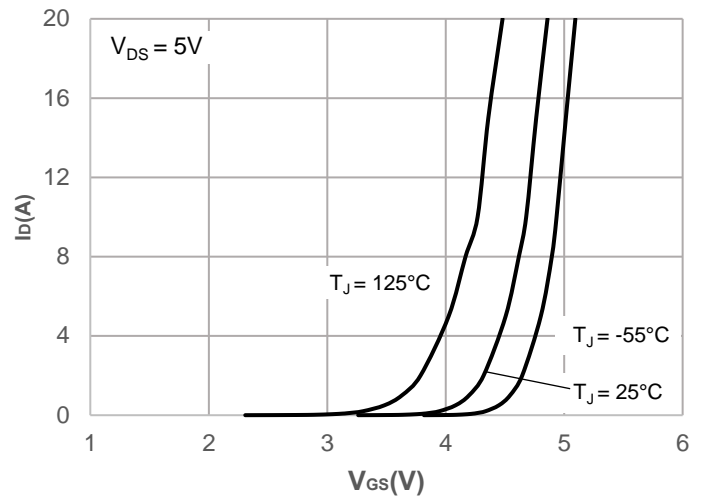
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
2. EAS condition: Starting T<sub>J</sub>=25°C, V<sub>DD</sub>=75V, V<sub>G</sub>=10V, R<sub>G</sub>=25ohm, L=3mH, I<sub>AS</sub>=18.9A, V<sub>DD</sub>=0V during time in avalanche.
3. RθJA is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB.
4. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%.
5. This value is guaranteed by design hence it is not included in the production test.

**Typical Characteristics**

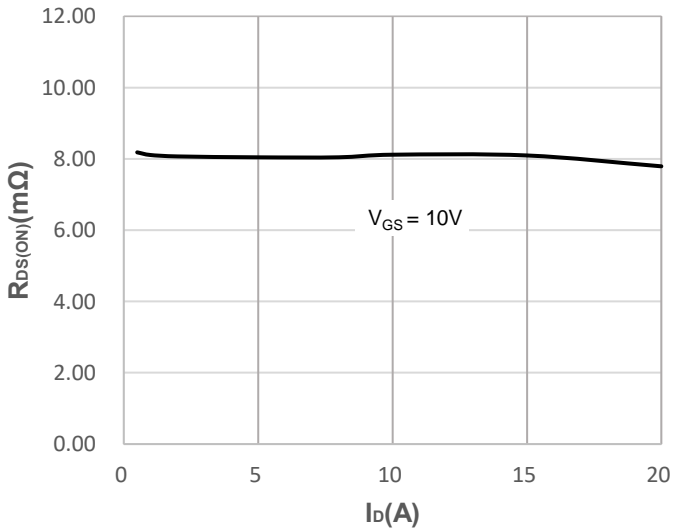
**Figure 1: Output Characteristics**



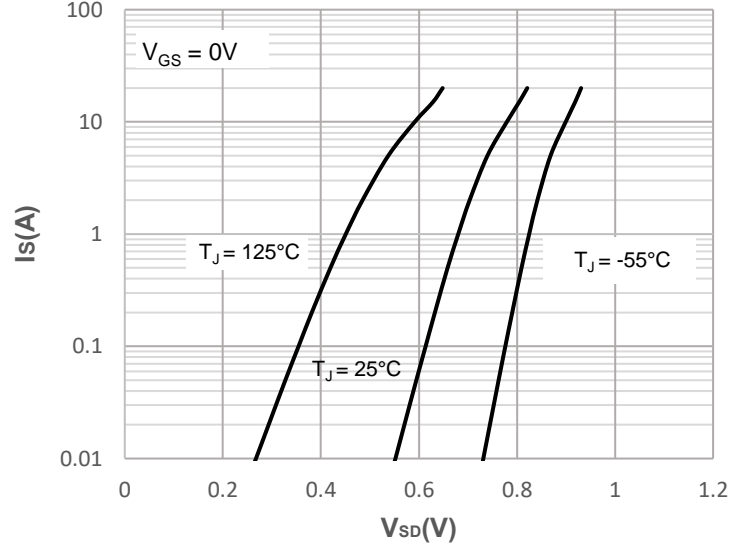
**Figure 2: Typical Transfer Characteristics**



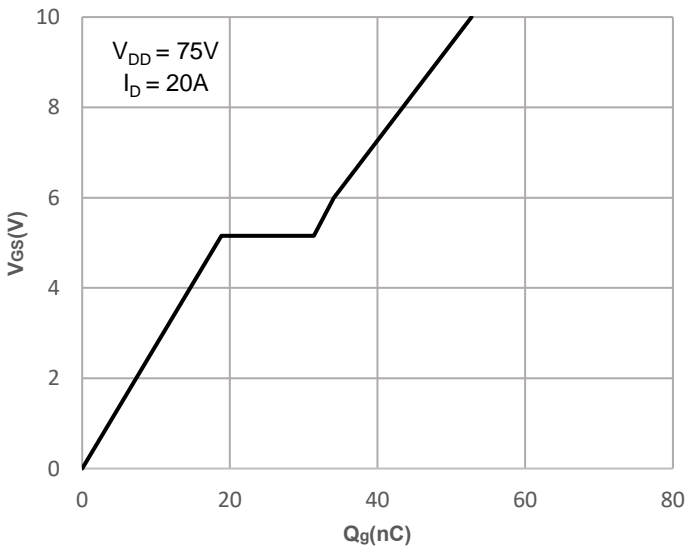
**Figure 3: On-resistance vs. Drain Current**



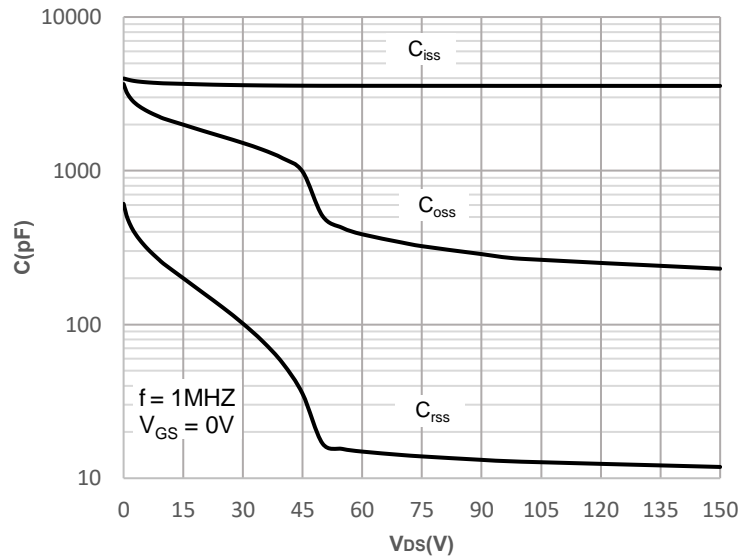
**Figure 4: Body Diode Characteristics**



**Figure 5: Gate Charge Characteristics**

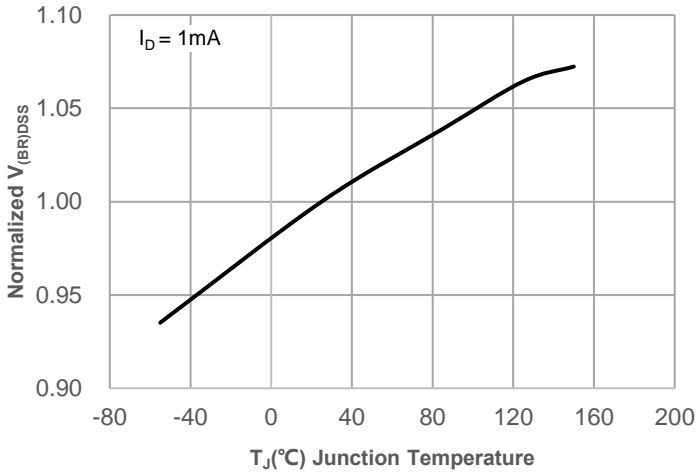


**Figure 6: Capacitance Characteristics**

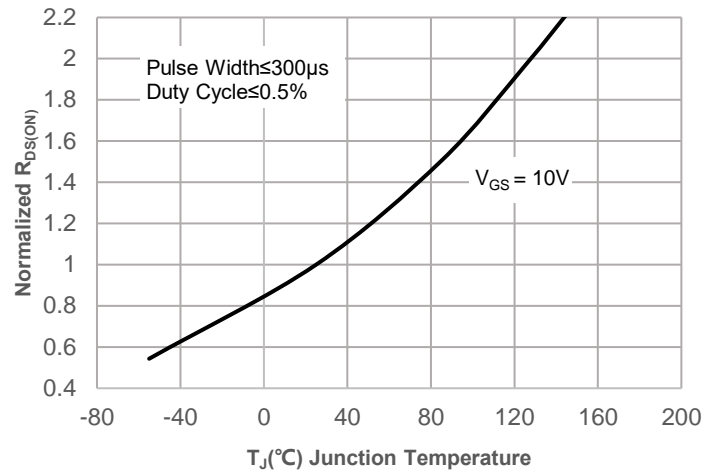


**Typical Characteristics**

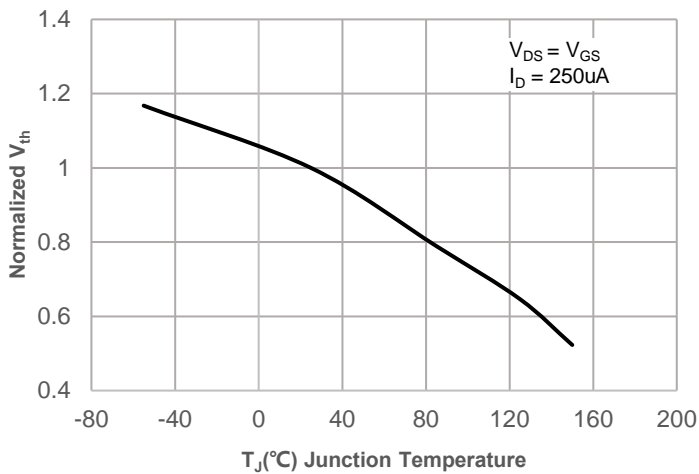
**Figure 7: Normalized Breakdown voltage vs. Junction Temperature**



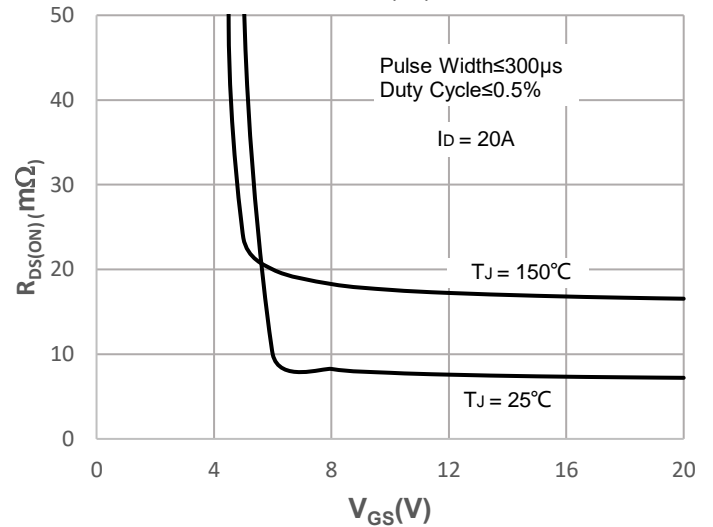
**Figure 8: Normalized on Resistance vs. Junction Temperature**



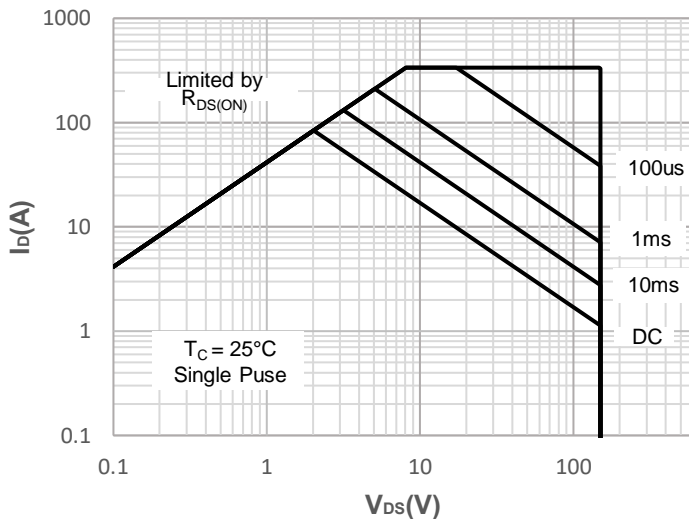
**Figure 9: Normalized Threshold Voltage vs. Junction Temperature**



**Figure 10: RDS(ON) vs. VGS**

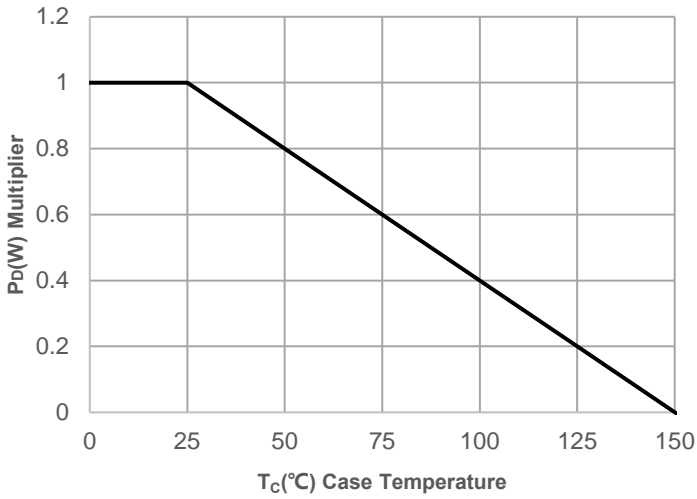


**Figure 11: Maximum Safe Operating Area**

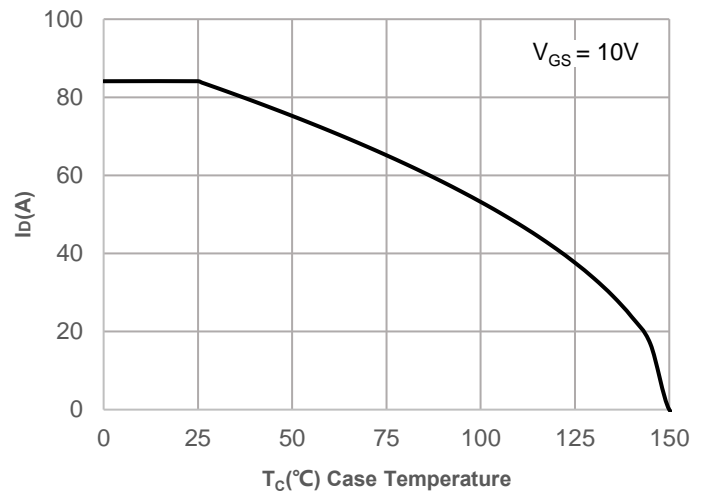


**Typical Characteristics**

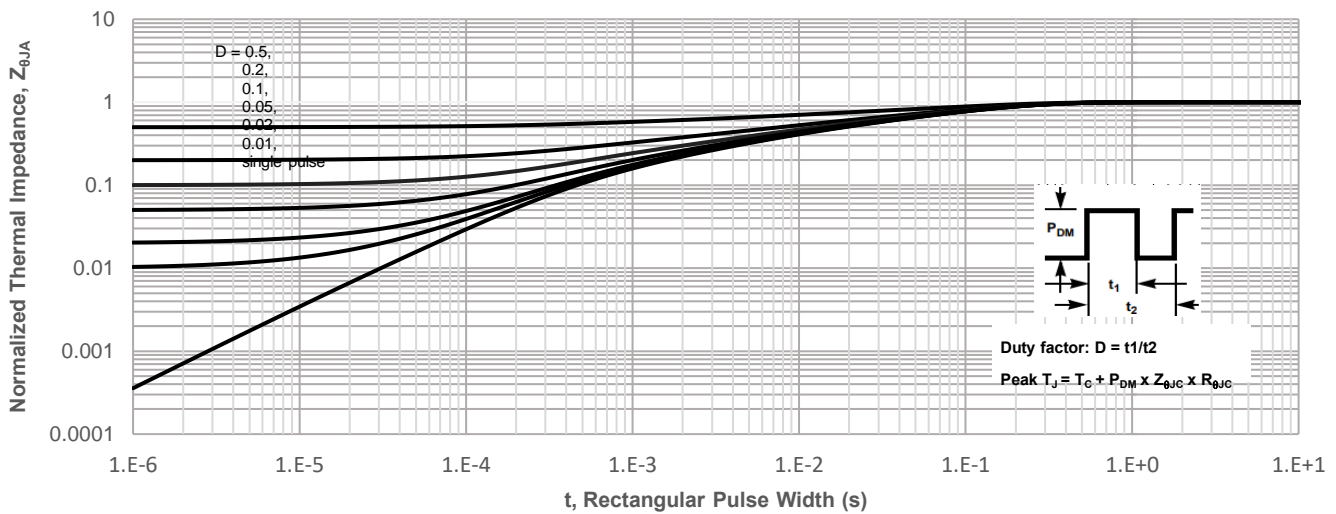
**Figure 12: Power De-rating**



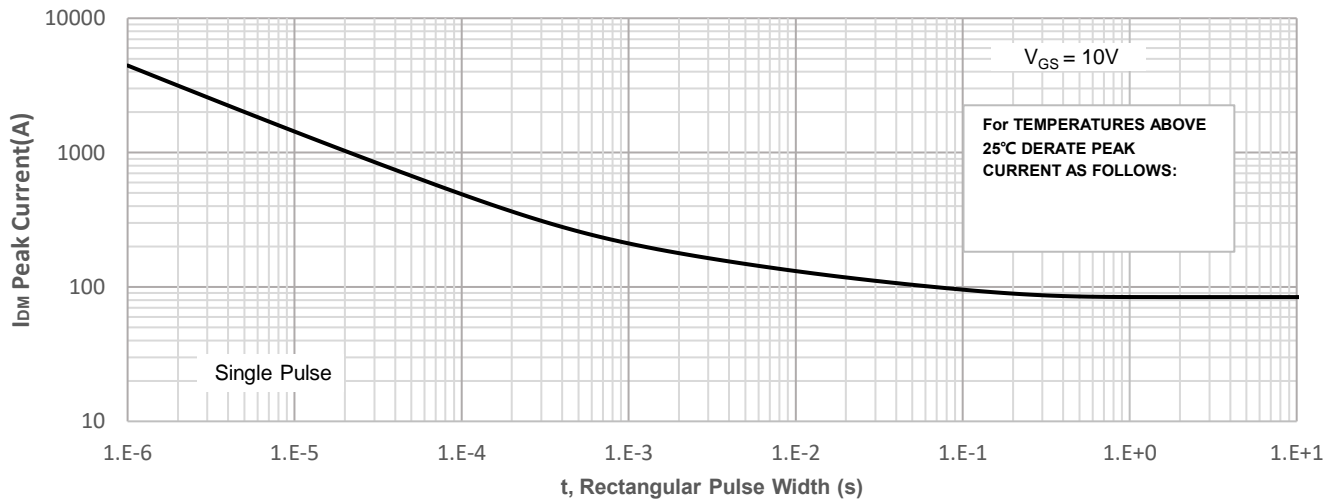
**Figure 13: Current De-rating**



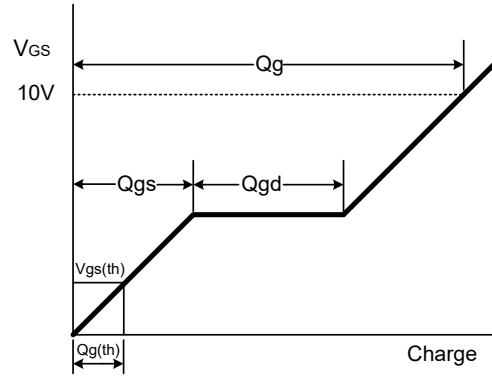
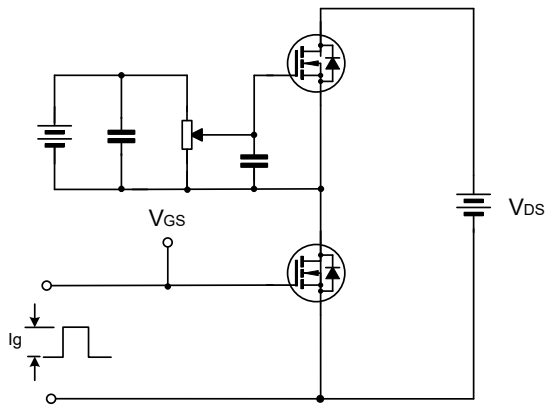
**Figure 14: Normalized Maximum Transient Thermal Impedance**



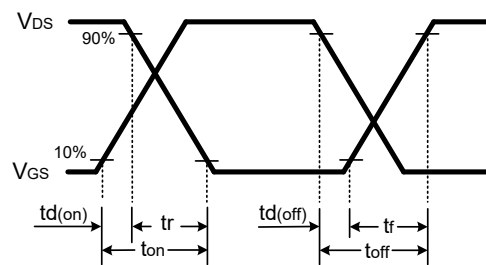
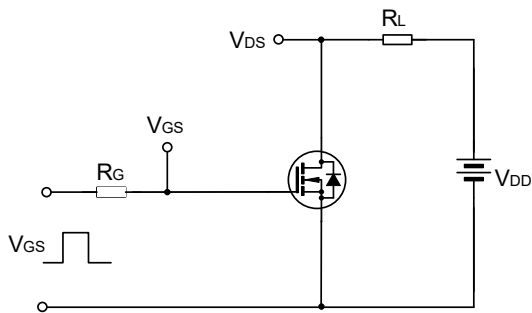
**Figure 15: Peak Current Capacity**



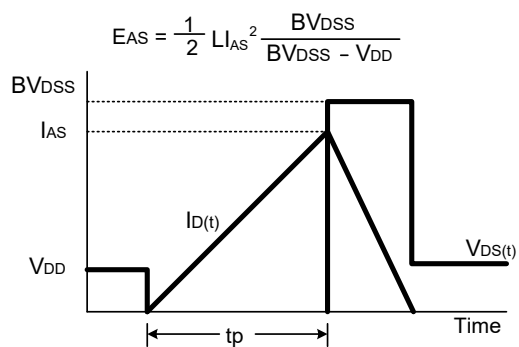
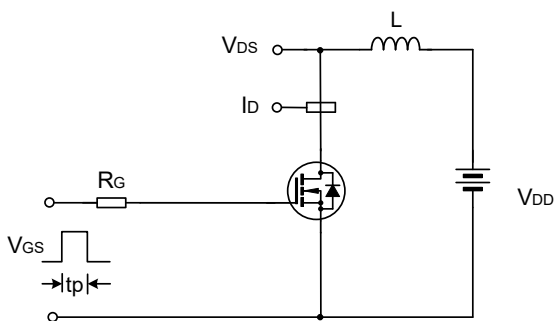
**Gate Charge Test Circuit & Waveform**



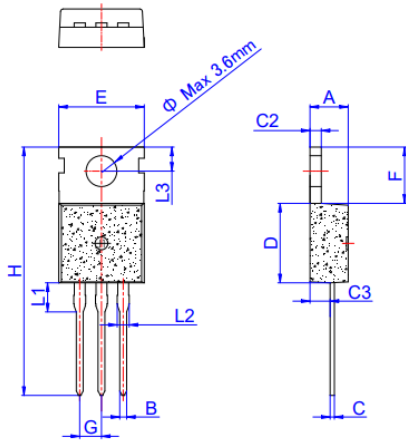
**Resistive Switching Test Circuit & Waveform**



**EAS Test Circuit & Waveform**



**TO-220-3L-C Package Information**



TO-220C

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.70		0.90	0.028		0.035
C	0.45		0.60	0.018		0.024
C2	1.23		1.32	0.048		0.052
C3	2.20		2.60	0.087		0.102
D	8.90		9.90	0.350		0.390
E	9.90		10.3	0.390		0.406
F	6.30		6.90	0.248		0.272
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.39			0.133	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
Φ		3.6			0.142	

**Attention:**

- GreenPower Electronics reserves the right to improve product design function and reliability without notice.
- Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.
- GreenPower Electronics products belong to consumer electronics or other civilian electronic products.